

4V Drive Nch MOSFET

RSJ650N10

Structure

Silicon N-channel MOSFET

Features

- 1) Low on-resistance.
- 2) High power package.
- 3) 4V drive.

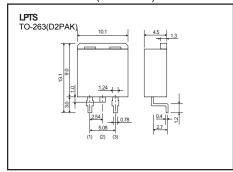
Application

Switching

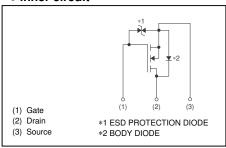
Packaging specifications

	Package	Taping
Type	Code	TL
	Quantity (pcs)	1000
RSJ650N10		0

• Dimensions (Unit : mm)



Inner circuit



● Absolute maximum ratings (Ta = 25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		V_{DSS}	100	V
Gate-source voltage	V_{GSS}	±20	V	
Drain current	Continuous	I _D *3	±65	Α
	Pulsed	I _{DP} *1	±130	Α
Source current	Continuous	l _S *3	65	Α
(Body Diode)	Pulsed	I _{SP} *1	130	Α
Power dissipation	P _D *2	100	W	
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg	-55 to +150	°C

^{*1} P_W≤10μs, Duty cycle≤1%

• Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to Case	Rth (ch-c)*	1.25	°C / W

^{*} T_C=25°C

^{*2} T_C=25°C

^{*3} Please use within the range of SOA.

● Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I _{GSS}	1	-	±10	μA	$V_{GS}=\pm20V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	100	-	-	٧	$I_D=1mA$, $V_{GS}=0V$
Zero gate voltage drain current	I _{DSS}	1	-	1	μA	$V_{DS} = 100V, V_{GS} = 0V$
Gate threshold voltage	V _{GS (th)}	1	-	2.5	٧	$V_{DS}=10V$, $I_{D}=1mA$
Static drain-source on-state		1	6.5	9.1	mΩ	I _D =32.5A, V _{GS} =10V
resistance	R _{DS (on)}	1	7	9.8	11122	$I_D=32.5A, V_{GS}=4V$
Forward transfer admittance	ΙΥ _{fs} Γ	45	-	-	S	V _{DS} =10V, I _D =32.5A
Input capacitance	C _{iss}	1	10780	-	рF	V _{DS} =25V
Output capacitance	C _{oss}	1	785	-	рF	V _{GS} =0V
Reverse transfer capacitance	C_{rss}	1	560	-	рF	f=1MHz
Turn-on delay time	t _{d(on)} *	1	45	-	ns	V _{DD} ≒50V, I _D =32.5A
Rise time	t _r *	1	170	-	ns	V _{GS} =10V
Turn-off delay time	t _{d(off)} *	1	640	-	ns	$R_L=1.54\Omega$
Fall time	t _f *	1	480	-	ns	$R_G=10\Omega$
Total gate charge	Q _g *	-	260	-	nC	V _{DD} ≒50V, I _D =32.5A
Gate-source charge	Q _{gs} *	-	24	-	nC	V _{GS} =10V
Gate-drain charge	Q _{gd} *	-	60	_	nC	

^{*}Pulsed

●Body diode characteristics (Source-Drain)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward Voltage	V _{SD} *	-	-	1.5	V	$I_s=65A, V_{GS}=0V$

^{*}Pulsed

●Electrical characteristic curves (Ta=25°C)

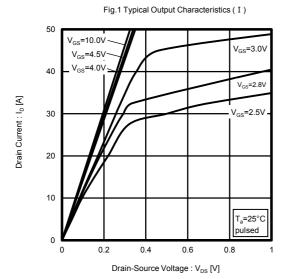


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

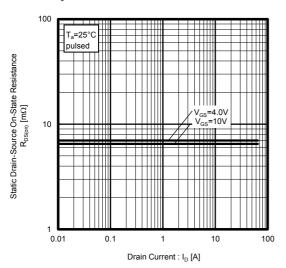


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

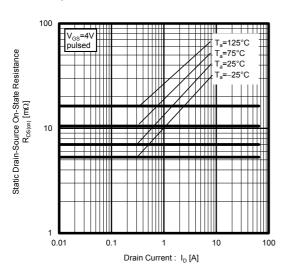


Fig.2 Typical Output Characteristics (${\rm I\hspace{-.1em}I}$)

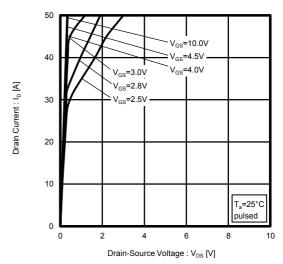


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

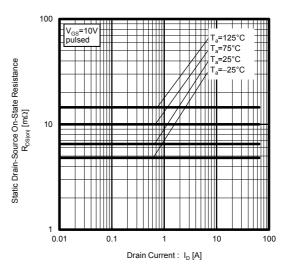


Fig.6 Forward Transfer Admittance vs. Drain Current

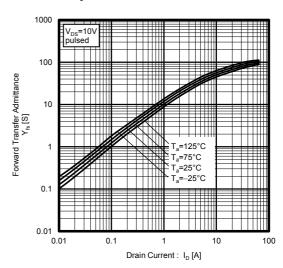
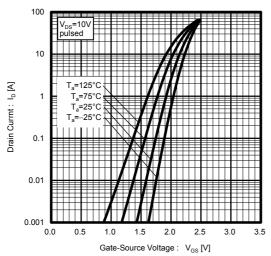


Fig.7 Typical Transfer Characteristics



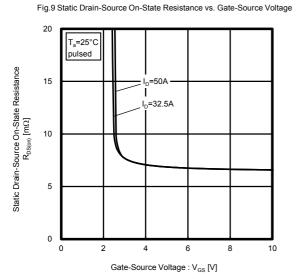


Fig.11 Dynamic Input Characteristics

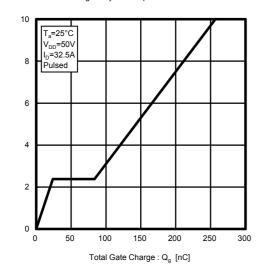


Fig.8 Source Current vs. Source-Drain Voltage

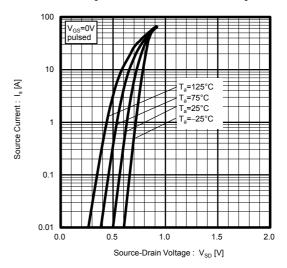


Fig.10 Switching Characteristics

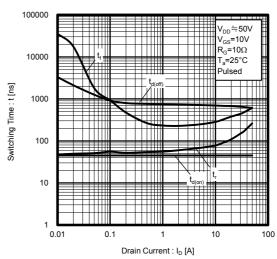
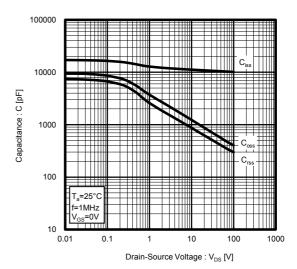


Fig.12 Typical Capacitance vs. Drain-Source Voltage



Gate-Source Voltage: V_{GS} [V]

Fig.13 Normalized Transient Thermal Resistance v.s. Pulse Width

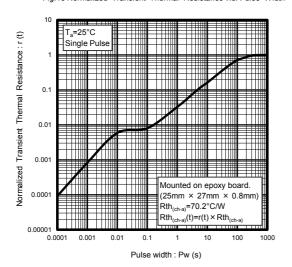
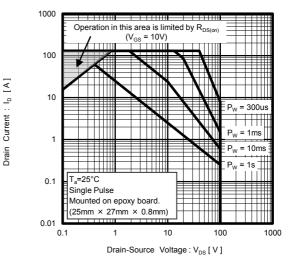


Fig.14 Maximum Safe Operating Area



Measurement circuits

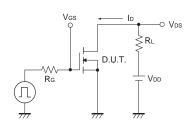


Fig.1-1 Switching Time Measurement Circuit

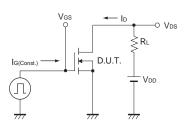


Fig.2-1 Gate Charge Measurement Circuit

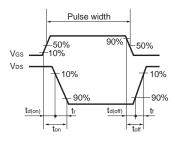


Fig.1-2 Switching Waveforms

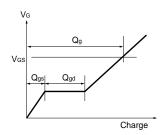


Fig.2-2 Gate Charge Waveform

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JAPAN	USA	EU	CHINA
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CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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